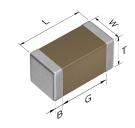
Multilayer Ceramic Chip Capacitors C1608X5R1E155M080AB

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TDK item description C1608X5R1E155MT****

Applications	Commercial Grade	
Feature	General (Up to 75V)	
Series	C1608 [EIA 0603]	
Status	Production (Not Recommended for New Design)	



	Size
Length(L)	1.60mm ±0.10mm
Width(W)	0.80mm ±0.10mm
Thickness(T)	0.80mm ±0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)
Recommended Land Fattern (FA)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
Necommended Land Fattern (FB)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
Necommended Land Factern (FC)	0.60mm to 0.80mm(Reflow Soldering)

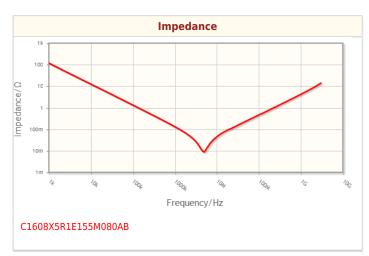
Electrical Characteristics		
Capacitance	1.5μF ±20%	
Rated Voltage	25VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	333ΜΩ	

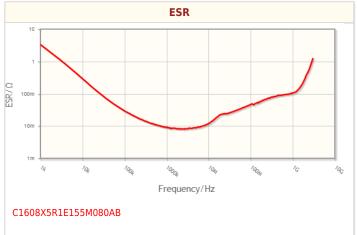
	Other
Coldoring Mathod	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	NO
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

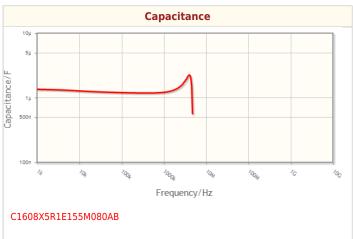
 $^{!\ \}mbox{Images}$ are for reference only and show exemplary products.

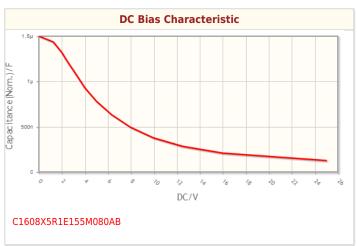
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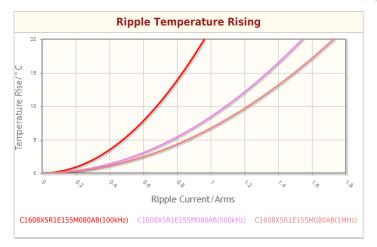
 $^{! \ \}mbox{All specifications}$ are subject to change without notice.











[!] Images are for reference only and show exemplary products.

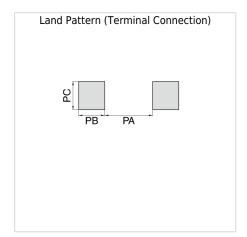
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Associated Images



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